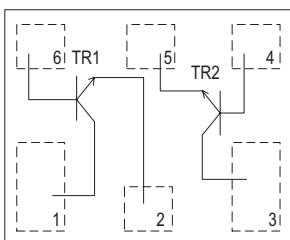
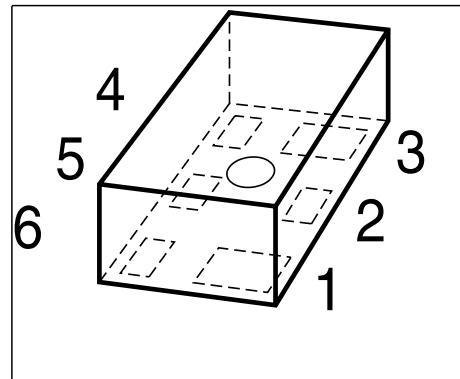


NPN Silicon RF TWIN Transistor

- High f_T of 22 GHz
- For low voltage / low current applications
- Ideal for VCO modules and low noise amplifiers
- Low noise figure: 1.1 dB at 1.8 GHz
- World's smallest SMD 6-pin leadless package
- Excellent ESD performance
- Built in 2 transistors (TR1, TR2: die as BFR460L3)

* Short-term description



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration						Package
BFS460L6	AB	1=C1	2=E1	3=C2	4=B2	5=E2	6=B1	TSLP-6-1

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage $T_A > 0^\circ\text{C}$	V_{CEO}	4.5	V
$T_A \leq 0^\circ\text{C}$		4.2	
Collector-emitter voltage	V_{CES}	15	
Collector-base voltage	V_{CBO}	15	
Emitter-base voltage	V_{EBO}	1.5	
Collector current	I_C	50	mA
Base current	I_B	5	
Total power dissipation ¹⁾ $T_S \leq 104^\circ\text{C}$	P_{tot}	200	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

¹ T_S is measured on the collector lead at the soldering point to the pcb

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R_{thJS}	≤ 230	K/W

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

DC Characteristics

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	4.5	5.8	-	V
Collector-emitter cutoff current $V_{CE} = 15 \text{ V}, V_{BE} = 0$	I_{CES}	-	-	10	μA
Collector-base cutoff current $V_{CB} = 5 \text{ V}, I_E = 0$	I_{CBO}	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 0.5 \text{ V}, I_C = 0$	I_{EBO}	-	-	1	μA
DC current gain $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, \text{pulse measured}$	h_{FE}	90	120	160	-

¹⁾For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 30 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1 \text{ GHz}$	f_T	16	22	-	GHz
Collector-base capacitance $V_{CB} = 3 \text{ V}, f = 1 \text{ MHz}, \text{emitter grounded}$	C_{cb}	-	0.33	0.5	pF
Collector emitter capacitance $V_{CE} = 3 \text{ V}, f = 1 \text{ MHz}, \text{base grounded}$	C_{ce}	-	0.17	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, \text{collector grounded}$	C_{eb}	-	0.57	-	
Noise figure $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1.8 \text{ GHz}$ $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 3 \text{ GHz}$	F	-	1.1	-	dB
-		-	1.4	-	
Power gain, maximum stable ¹⁾ $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$ $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 3 \text{ GHz}$	G_{ms}	-	14.5	-	dB
-		-	10	-	
Transducer gain $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$ $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega, f = 3 \text{ GHz}$	$ S_{21e} ^2$	-	12.5	-	
-		-	9	-	
Third order intercept point at output ²⁾ $V_{CE} = 3 \text{ V}, I_C = 20 \text{ mA}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$	IP_3	-	28	-	dBm
1dB Compression point at output $I_C = 20 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$	$P_{-1\text{dB}}$	-	12	-	

¹ $G_{ma} = |S_{21e}| / S_{12e} (k - (k^2 - 1)^{1/2})$, $G_{ms} = |S_{21e}| / S_{12e}|$
² IP_3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz